

规格书编号

**SPEC NO:** 

# 产品规格书 SPECIFICATION

CUSTOMER 客户:							
PRODUCT 产品:	SAW FILTER						
MODEL NO 型 号:	HDF315MT039						
PREPARED 编 制:	CHECKED 审 核	﴿:					
APPROVED 批 准:	DATE 日 期	月 <b>:</b> 2006−5−11					
客户确认 CUSTOMER RECEIVED:							
审核 CHECKED	批准 APPROVED	日期 DATE					

无锡市好达电子有限公司 Shoulder Electronics Limited SAW FILTER HDF315MTO39

# 更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark



# 1. SCOPE

**SAW FILTER** 

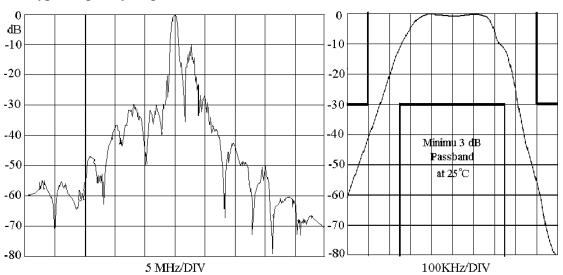
This specification shall cover the characteristics of SAW filter 315MHz with used for remote-control security.

# 2. ELECTRICAL SPECIFICATION

DC Voltage VDC	10V
AC Voltage Vpp	10V50Hz/60Hz
Operation temperature	-40°C to +85°C
Storage temperature	-45°C to +85°C
Max Input Power	10dBm

**Electronic Characteristics** 

# 2-1. Type frequency response



#### 2-2. Electrical characteristics

	Characteristic	Sym	Notes	Min	Typical	Max	Units
Center	Absolute frequency	Fc	1.2	314.920	315.000	315.080	MHz
frequency	Tolerance from nominal	Δ fc				±80	KHz
Insertion Lo	OSS	IL	1		1.7	3.0	dB
3dB Bandw	ridth	BW3	1.2	500	700	800	KHz
Passband R	ipple (Fc ± 400 KHz)				0.2	0.5	dB
	At fo-21.4MHz (Image)			40	50		
Rejection	At fo-10.7 MHz (LO)		1	16	40		dB
	Ultimate				80		
	Operating case temp.	Тс	3.4	-35		+85	$^{\circ}\mathbb{C}$
Temperatur	e Tumor temp.	То		22	37	62	$^{\circ}\!\mathbb{C}$
characterist	ics Tumover Frequency	fo			fc		MHz
	Fre.temp.coeficient	FTC			0.032		ppm/°C
Frequency aging			5		<±10		ppm/y

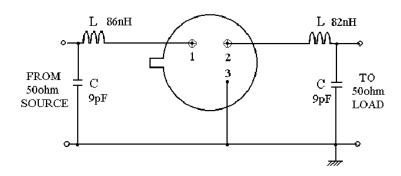


SAW FILTER HDF315MTO39

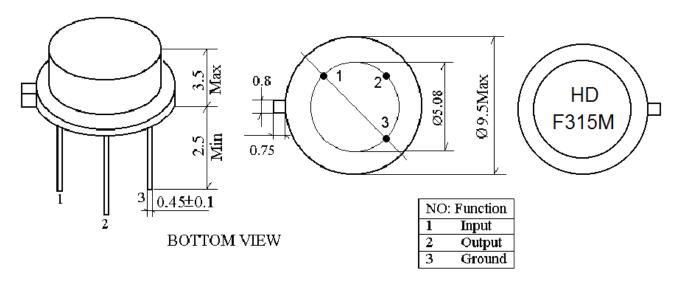
#### Note:

- 1. Typical test circuit is shown as below.
- 2. Passband and reject bands are specified in reference to fc.
- 3. The turnover temperature, To, is the temperature at the maximum frequency, Fo.
- 4. The nominal frequency at any case temperature, Tc, inside the operating temperature range may be calculated from:f=fo[1-FTC(To-Tc)<sup>2</sup>].
- 5. Typical aging is for 10 years.

# 3. TEST CIRCUIT



## 4. DIMENSION



# 5. ENVIRONMENTAL CHARACTERISTICS

5-1 High temperature exposure

Subject the device to  $+85^{\circ}$ C for 16 hours. Then release the filter into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2-2.

5-2 Low temperature exposure



# SAW FILTER HDF315MTO39

Subject the device to  $-40^{\circ}$ C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2-2.

## 5-3 Temperature cycling

Subject the device to a low temperature of  $-40^{\circ}$ C for 30 minutes. Following by a high temperature of  $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 2-2.

#### 5-4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at  $260^{\circ}$ C  $\pm 10^{\circ}$ C for  $10\pm 1$  sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2-2.

#### 5-5 Solderability

Subject the device terminals into the solder bath at  $245^{\circ}$ C  $\pm 5^{\circ}$ C for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in 2-2.

#### 5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2-2.

#### 5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2-2.

#### 6. REMARK

#### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

#### 6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

# 6.3 Soldering

Only leads of component may be solded. Please avoid soldering another part of component.